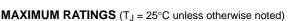
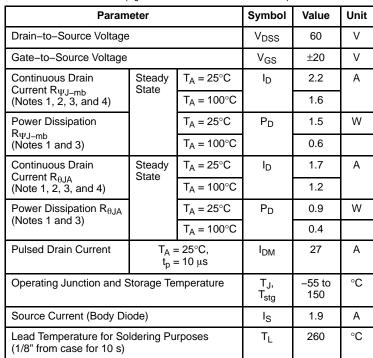
Power MOSFET

60 V, 155 m Ω , Single N–Channel Logic Level, SOT–23

Features

- Small Footprint Industry Standard Surface Mount SOT-23 Package
- Low R_{DS(on)} for Low Conduction Losses and Improved Efficiency
- NVR Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant





Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Psi (Ψ) is used as required per JESD51–12 for packages in which substantially less than 100% of the heat flows to single case surface.
- 3. Surface-mounted on FR4 board using a 650 mm2, 2 oz. Cu pad.
- 4. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

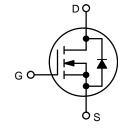


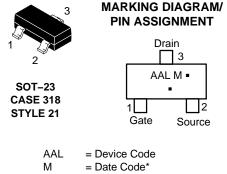
ON Semiconductor®

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| V _{(BR)DSS} | R _{DS(on)} TYP | I _D MAX |
|----------------------|-------------------------|--------------------|
| 60 V | 155 mΩ @ 10 V | 2.2 A |
| | 205 mΩ @ 4.5 V | / |







= Pb–Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping [†] | | |
|--------------|---------------------|------------------------|--|--|
| NVR5198NLT1G | SOT-23 (Pb-Free) | 3000 / Tape & Reel | | |
| NVR5198NLT3G | SOT-23 (Pb-Free) | 10000 / Tape & Reel | | |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL RESISTANCE RATINGS

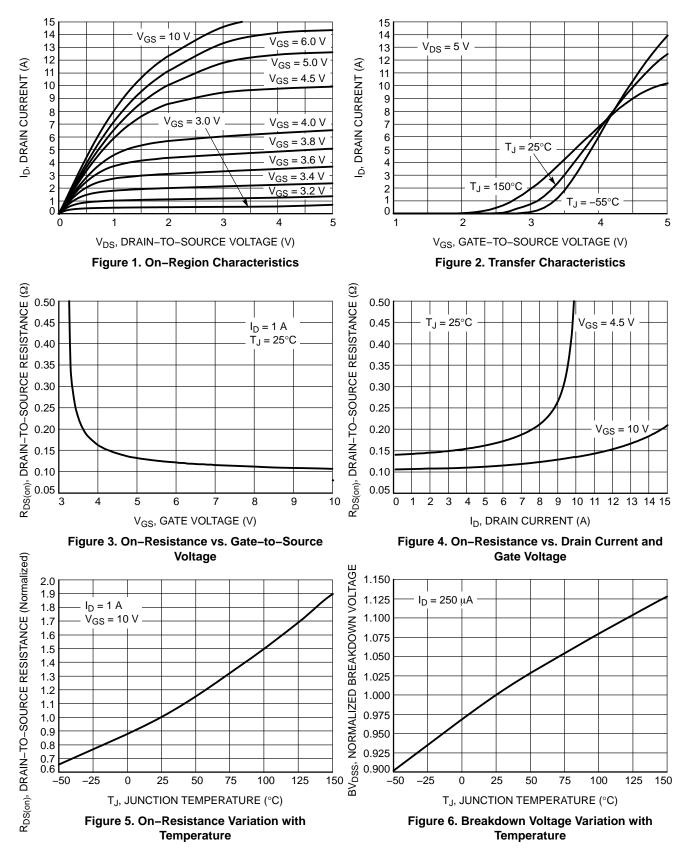
| Parameter | Symbol | Max | Unit |
|---|----------------|-----|------|
| Junction-to-Lead #3 - Drain (Notes 2 and 3) | $R_{\PsiJ-mb}$ | 86 | °C/W |
| Junction-to-Ambient - Steady State (Note 3) | R_{\thetaJA} | 139 | °C/W |

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

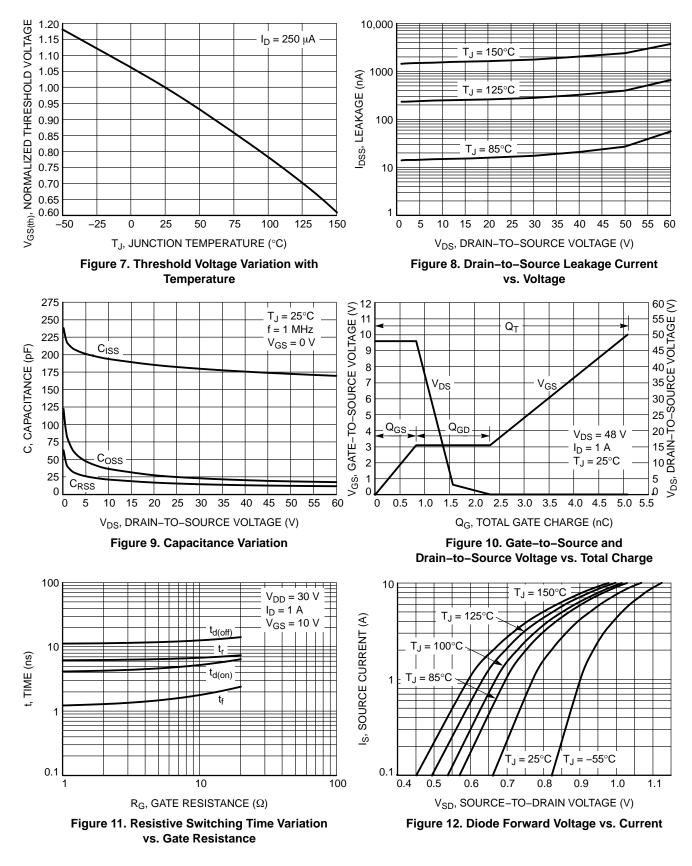
| Parameter | Symbol | Test Conditions | | Min | Тур | Max | Unit |
|--|--------------------------------------|---|-------------------------|-----|----------|----------|------|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | V _{GS} = 0 V, I _D = 250 μA | | 60 | | | V |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} /T _J | Reference to 25°C, $I_D = 250 \ \mu A$ | | | 70 | | mV/° |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{GS} = 0 V,$ | $T_J = 25^{\circ}C$ | | | 1.0 | μΑ |
| <u> </u> | | $V_{DS} = 60 \text{ V}$ | T _J = 125°C | | | 10 | 1 |
| Gate-to-Source Leakage Current | I _{GSS} | V _{DS} = 0 V, V | / _{GS} = ±20 ∨ | | | ±100 | nA |
| ON CHARACTERISTICS (Note 5) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | $V_{GS} = V_{DS},$ | I _D = 250 μA | 1.5 | | 2.5 | V |
| Threshold Temperature Coefficient | V _{GS(TH)} /T _J | Reference to 25° C, I _D = 250 µA | | | -6.5 | | mV/° |
| Drain-to-Source On-Resistance | R _{DS(on)} | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A}$ | | | 107 | 155 | mΩ |
| ······································ | () | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 1 \text{ A}$ | | | 142 | 205 | |
| Forward Transconductance | 9FS | $V_{DS} = 5.0 \text{ V}, \text{ I}_{D} = 1 \text{ A}$ | | | 3 | | S |
| CHARGES, CAPACITANCES & GAT | E RESISTANCE | | | | | | |
| Input Capacitance | C _{iss} | | | 182 | | pF | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 V, f$ | = 1.0 MHz, | | 25 | | |
| Reverse Transfer Capacitance | C _{rss} | V _{DS} = 25 V | | | 16 | | |
| Total Gate Charge | Q _{G(TOT)} | V _{DS} = 48 V, I _D = 1 A | V _{GS} = 4.5 V | | 2.8 | | nC |
| | 0(101) | | V _{GS} = 10 V | | 5.1 | | |
| Threshold Gate Charge | Q _{G(TH)} | | | | 0.3 | | |
| Gate-to-Source Charge | Q _{GS} | Vpc = 48 | V, I _D = 1 A | | 0.8 | | |
| Gate-to-Drain Charge | Q _{GD} | V _{GS} = | = 10 V | | 1.5 | | 1 |
| Plateau Voltage | V _{GP} | | | | 3.1 | | V |
| Gate Resistance | R _G | <u> </u> | | | 8 | | Ω |
| SWITCHING CHARACTERISTICS | | | | | <u>.</u> | <u>.</u> | |
| Turn-On Delay Time | t _{d(on)} | | | | 5 | | ns |
| Rise Time | t _r | Vpc = 30 V | V _{GS} = 10 V, | | 7 | | |
| Turn–Off Delay Time | t _{d(off)} | $I_{\rm D} = 1 {\rm A}, {\rm I}$ | $R_{\rm G} = 10 \Omega$ | | 13 | | |
| Fall Time | t _f | | | | 2 | | - |
| DRAIN-SOURCE DIODE CHARACT | | | | | | | |
| Forward Diode Voltage | V _{SD} | $V_{GS} = 0 V,$ $I_{S} = 1 A$ | T _J = 25°C | | 0.8 | 1.2 | V |
| - | | | T _J = 125°C | | 0.6 | | |
| Reverse Recovery Time | t _{rr} | $I_{S} = 1 A_{dc}, V_{GS} = 0 V_{dc},$ $dI_{S}/dt = 100 A/\mu s$ | | 1 | 12 | 1 | ns |
| Charge Time | t _a | | | | 9 | | |
| Discharge Time | t _b | | | | 3 | | 1 |
| Reverse Recovery Stored Charge | Q _{RR} | | | | 6 | | nC |

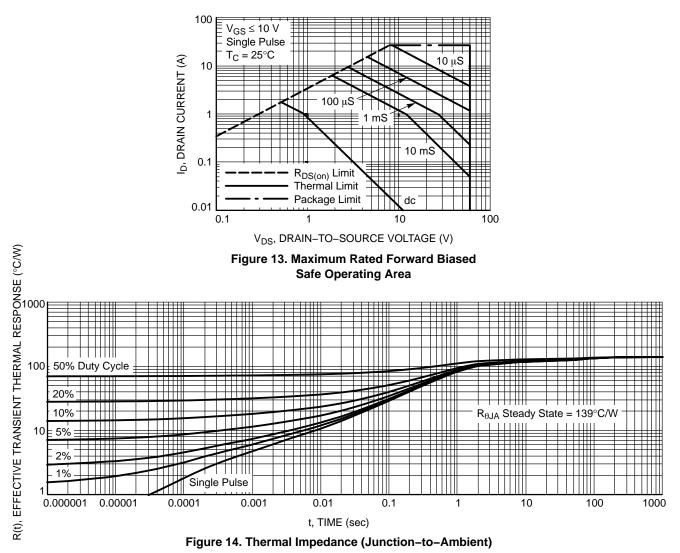
performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%. 6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS





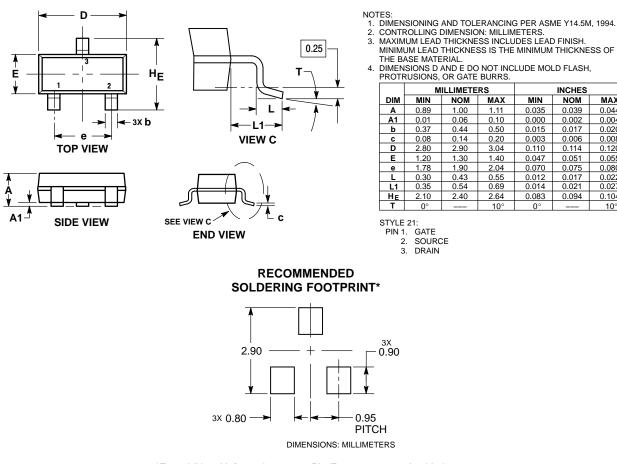




TYPICAL CHARACTERISTICS

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AR**



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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